

## Leti Innovation Days to explore microelectronics' role in enabling transformational technologies – June 1, 2023

### NEWS



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**L**eti Innovation Days, CEA-Leti's annual signature event, will take place on June 27–29, at the company's headquarters in Grenoble, France, and is to explore microelectronics' role in enabling transformational technologies.

CEA-Leti research engineers, top executives at leading global companies and entrepreneurs will gather to share their insights on technological challenges and opportunities facing industry, government and society in the coming years.

The event, the official theme of which is *Transformational technologies for your products and our future*, will kick off with a plenary session on June 27, in which leaders will explore the semiconductor industry's position at the centre of technological advances transforming society.

Representatives from the entire microelectronics value chain—from equipment manufacturers to product designers and foundries—will be onsite to participate in workshops, demos and discussions.

Pat Gelsinger, CEO at Intel, will head the opening plenary session of speakers, who include:

- **Gregg Bartlett, CTO, Global Foundries;**
- **Ned Curic, CTO, Stellantis;**
- **David André, CSO, Google X;**
- **Frédéric Godemel, EVP, Schneider Electric;**
- **Agnieszka Thonet, VP, HP;**
- **Pierre Barnabé, CEO, Soitec;**
- **Sébastien Dauvé, CEO, CEA-Leti; and**
- **Michael Tchagopianian, Event Chairman, CEA-Leti.**

In addition, this year's event will feature dedicated workshops on:

- **sustainable electronics;**
- **quantum computing;**
- **tomorrow's cybersecurity;**
- **devices for edge AI;**
- **Photonics: data and sensing; and**
- **RF and telecommunications.**

The gathering at the institute's Grenoble facility will again feature partners' and startups' corners and live demos of emerging technologies, along with many opportunities for participants to network and exchange ideas.

The startups' corner will include:

- **Active Digital Multispectral InfraRed (ADMIR);**
- **Arise;**
- **Balo-dx;**
- **Direct Analysis;**
- **Evercyb;**
- **Injectpower;**
- **Orlona;**
- **Scintil Photonics;**
- **Siquance;**
- **SteerLight;**
- **Wise Integration; and**
- **Wormsensing.**

Sébastien Dauvé, CEO at CEA-Leti, commented, "We will gather semiconductor-industry executives, thought leaders and decision makers from around the world to come together to redefine what it means to develop fair, sustainable and trusted technologies, and come away with deep-tech solutions from lab to fab that support human healthcare and sustainable microelectronics initiatives."

Leti Innovation Days is sponsored by Applied Materials, ASML, Crédit Agricole Sud Rhône-Alpes, EBARA, Edwards, Entegris, EV Group (EVG), JSR Micro, LAM Research, Lynred, Murata, Schneider Electric, SCREEN Semiconductor Solutions Co., Siemens, Soitec, STMicroelectronics, Tokyo Electron Ltd (TEL) and Weebit Nano, with support from the Auvergne Rhône-Alps Region, Carnot Institutes network, Grenoble Alpes Métropole and SEMI.

For more information, visit: <https://www.leti-innovation-days.com>. ■

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